

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

PATENTS

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**Examiner:** Ron E. Pompey

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Assistant Commissioner for Patents  
United States Patent and Trademark Office  
Washington, D.C. 20231

**LETTER TO THE OFFICIAL DRAFTSMAN**

Sir:

Enclosed herewith is a photocopy of the informal drawings for the above referenced application containing proposed revisions hereto in red ink. Specifically, in FIG. 2E reference number 115 has been added to indicate the rounded corners of the conformal oxide layer, and reference lines 112 have been extended to more clearly indicate the conformal oxide layer.

The filing of formal drawings with the above corrections therein will be made when approval of the foregoing amendment has been indicated.

Respectfully submitted,

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Dated: January 24, 2003

Mishelle Mustafa

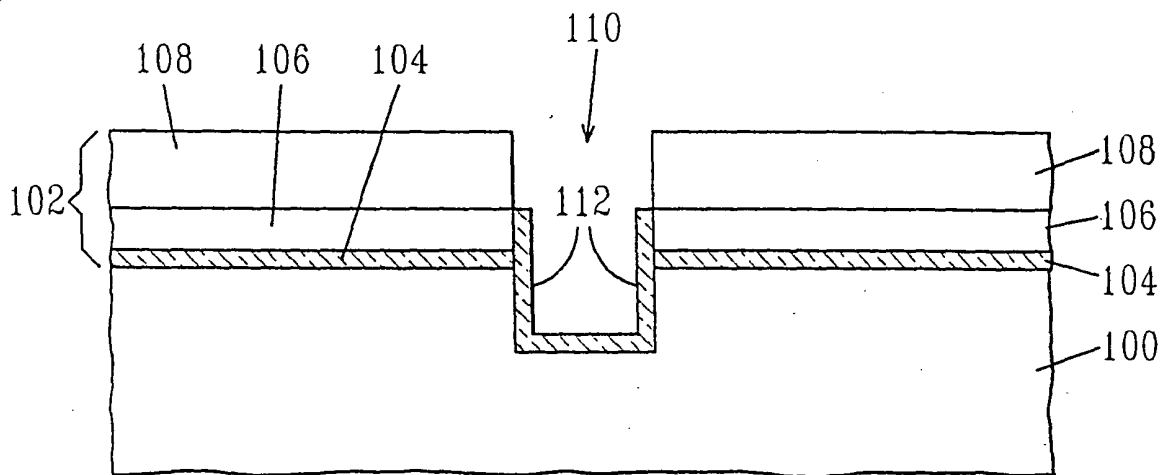


FIG. 2C

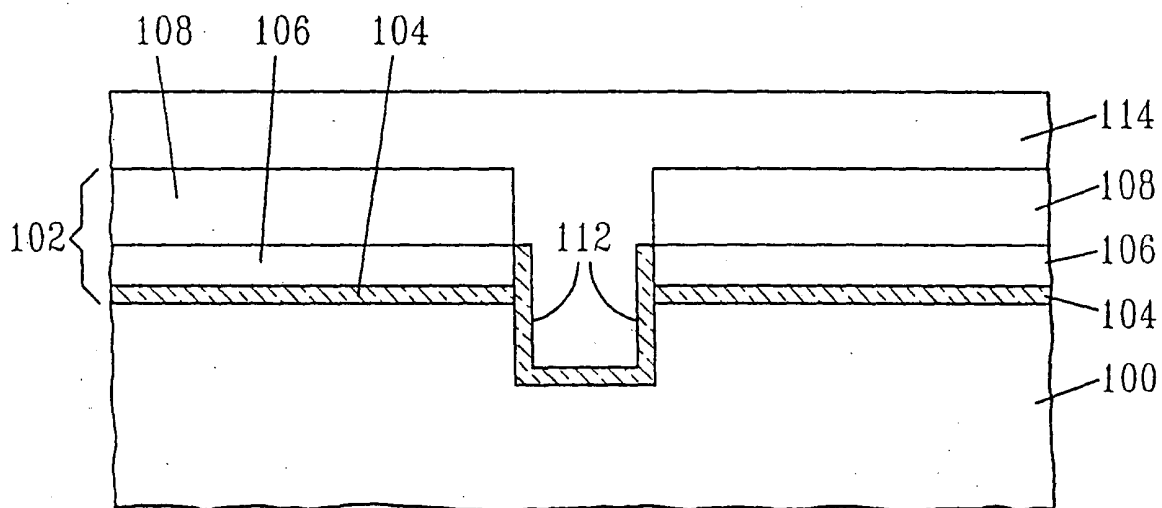


FIG. 2D

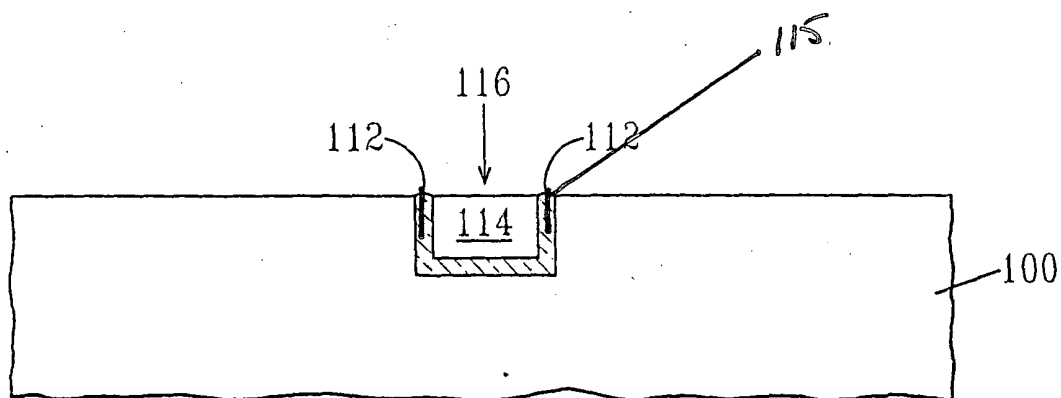


FIG. 2E